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1 Purpose and Scope

1.1 Purpose
The purpose of this manual is to provide guidance and a framework for optimizing process controls within a manufacturing environment.

1.2 Scope
This manual may apply to any manufacturing process.

2 Acronyms / Terminology and Description / Definition

Approved
The supplier status is such that Skyworks' Sourcing may buy qualified products from that supplier.

3 Associated Documents

National and International Standards
APQP AIAG Advanced Product Quality Planning and Control Plan Manual
FMEA AIAG Failure Mode Effects Analysis Manual
MSA AIAG Measurement Systems Analysis Manual
SPC AIAG Statistical Process Control Manual

4 General
Process Control Optimization or PCO, was initially developed as a supplier development tool however any organization can utilize these tools to improve the effectiveness and efficiency of their manufacturing process. It is based on the premise that the focus of a process control initiative should be on the process inputs, not the product parameters. All PCO guidelines must be met. PCO can be performed yearly or focused on a specific scope such as new technologies. 8D format will be prescribed to close critical gaps to PCO requirements. Suppliers are expected to own the action items defined & if needed form teams to address the concerns highlighted.
5  Process Control Optimization Tools

5.1  Product Specifications

The organization must ensure that the product specifications were determined based on some type of analysis, that these are clearly defined and used for end product testing. Product specifications mandated by the customer must be communicated to the line. The organization should demonstrate how they determined their internal product specifications (i.e. customer usage, market demands, statistics, capability, competition, etc.). Where applicable, the supplier’s product specification should be compared to the most recent Skyworks specification.

5.2  Process Definition

5.2.1 Process Flowchart

A process flowchart provides a visual approach for describing, developing, analyzing and improving sequential tasks. The organization should have a process flowchart(s) that represent the entire workflow from receiving through shipping. The flowchart should be updated as the process evolves. The flowchart should show process inputs, controls, activity and outputs (see example in Figure 5-1-1). Having individual flowcharts by area is acceptable. The flowchart and actual process flow observed in the factory should match.
### 5.2.2 Process Control Plans

The process control plan is an output of the control plan methodology which provides a structured approach to for the design, selection and implementation of value added process controls used to minimize product and process variation (referenced in the [AIAG APQP and Control Plan Manual](#)). All columns outlined in Appendix A of ISO/TS 16949 or in the AIAG APQP Control Plan manual should be included. Critical to quality (CTQ) parameters should be identified in the control plan. The control plan should be updated when the process is modified or enhanced. The control plan should have evidence of recent process change history. Actual process observed in factory should match control plan.

#### KEY POINT

The process control plan should include all process input parameters as well as significant product characteristics.

<table>
<thead>
<tr>
<th>Process Number</th>
<th>Process Name/Operations Description</th>
<th>Machine Device Jig Tools</th>
<th>Characteristics</th>
<th>Special Char Class</th>
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*Figure 5-2-1 Control Plan Template*
5.2.3 Out of Control Action Plan

Out of Control Action Plan, Reaction Plan or OCAP is a flowchart that describes a Product Anomaly or Process/Machine event and the steps reaction plan, containment actions, risk assessment, disposition to affected product(s) and the corrective/preventive actions to be done. A well defined reaction plan / OCAP should be tied in to items defined with high risk in the FMEA & for critical defects.

Figure 5-2-2 OCAP Example

5.2.4 Work Instructions

The organization must ensure that established work practices have been adequately captured in order to ensure that the product design can be consistently manufactured in a factory environment. Work instructions should adequately identify the steps required to successfully execute the process with minimal explanation. Work instructions should list required material, equipment, PPE, proper chemical disposal procedures, etc. Work instructions should be available at point of use. When run concurrently with normal production, engineering builds should be properly managed. Actual practice should follow work instructions.

5.2.5 Process Failure Mode Effects Analysis

A process failure mode effects analysis or FMEA identifies and mitigates high risk process controls (see Figure 5-3-1). Reference the AIAG FMEA Manual for specific instructions on how to generate an FMEA. The FMEA should include all processes and all process parameters (compare FMEA to process control plan parameters).
Example:

- *Part too thick* is not a process failure but rather the effect of a process failure
- *Pressure too low* is a process failure

The FMEA should show that a cross functional team approach is being used to develop the FMEA. There should be evidence that actions are continuously being taken on the highest RPNs, not based on an RPN threshold. FMEA items with severity ranking of 9 or 10 must be acted upon immediately. In the case where 2 or more risk items have the same RPN, priority should be given to those with highest severity. In a situation where the RPN limit is not being triggered, continuous improvement on the high RPN items is required. The FMEA should show evidence that it is being updated as a result of every process change, new process or new equipment or customer complaints. The FMEA should be a living document. The factory floor should demonstrate that any FMEA actions were actually deployed. Emphasis should be on prevention and error proofing (e.g. Poka-Yoke) versus detection.

### Figure 5-3-1

#### 5.2.6 Equipment Failure Mode Effects Analysis

Skyworks encourages suppliers to develop the equipment FMEA to identify the risks associated with equipment hardware failures. The objectives of the equipment FMEA are to aid in the planning of an effective preventive maintenance and increase the reliability and availability of the tool. Improvement actions must be defined for high RPN items for risk mitigation and there should be evidence of the actions implementation with effectiveness validation. The FMEA should be reviewed and updated periodically. Reference the *AIAG Machinery FMEA Manual* for specific instructions on how to generate equipment FMEA.

### 5.3 Process Validation

#### 5.3.1 Initial Process Studies

The initial process capability studies will provide early demonstration that the combination of people, machine, methods, material, and measurements will produce a product that will consistently meet the design requirements. Process studies should be performed on critical to quality process parameters. These parameters should have been determined using design of experiments. Process studies using corner parameters are encouraged to understand the process margins. The process study should first demonstrate process stability using appropriate control chart methodology. Sub group size...
should be calculated based on desired probability of detecting a shift. Capability studies should be performed on critical to quality process parameters once these can demonstrate stability and should achieve Cpk ≥ 1.67.

**KEY POINT**

Process studies should be performed on all critical to quality process parameters. Process capability can only be determined if the process is stable.

---

**Figure 5-14-1** A DOE can be used to identify the significant process characteristics

---

### 5.3.2 Internal Process Qualification

When suppliers perform internal process qualification activities, the qualification requirements should address the appropriate suite of manufacturing process validation data as well as any pertinent reliability concerns. Manufacturing data will include stability and capability data, as well as the manufacturing data from downstream processes. Parts submitted for reliability testing should be representative of a frozen manufacturing process. For applicable reliability tests, industry standards should be used as guidance for minimum requirements. Where possible, Skyworks test requirements should be adopted or equivalent tests need to be developed. Internal qualifications plans and results should be reviewed and approved by cross-functional teams within the supplier organization. For initial process qualification, risk assessment must be performed for equipment/material differences at the critical processes and this information to be shared to Skyworks upon request. Corner lots studies especially for critical process / high risk processes must be included even if no change is expected. Supplier should maximize the process tool/tool type coverage during the qualification phase.
5.3.3 Change Control Process
The process change control system of the supplier should define classes of changes, process validation requirements, approvers, customer PCN and change documentation requirements. All changes regardless of classification should have some level of process validation, require cross-disciplinary review, and provide PCN output consistent with JESD46. Skyworks encourage Suppliers to inform us of all changes so that we can work on the changes together.

5.3.4 Control Charts and Process Stability
Control charts are used to measure the stability of a process (reference the AIAG SPC Manual). They should be used on critical to quality process parameters. Data should be gathered using a measurement system with a gage R&R less than 10% (see paragraph 5.10). If the data becomes out of control, the reaction plan documented on the control plan (see paragraph 5.14) should be followed. Skyworks require the process capability (CPK) of critical processes to be between 1.67 to 3.00, if this requirement is not met, suppliers are requested to provide an improvement plan.

**KEY POINT**
SPC chart data should only be gathered using a measurement system with a gage R&R less than 10%

---
**Figure 5-14-1-1 Components of a Control Chart**

**Determining the Subgroup Size**
The subgroup size should be calculated based on process standard deviation and desired probability of detecting a process shift using the following formula:
\[ n = \frac{(Z_\alpha + Z_\beta)^2 \sigma^2}{D^2} \]

- **\( n \)**: Subgroup size
- **\( Z_{\alpha/2} \)**: The number of standard deviations above zero on the standard normal distribution such that the area in the tail of the distribution is \( \alpha/2 \) (\( \alpha \) is the type I error probability and is typically 0.0027 for control chart applications). As such, this value is typically \( Z_{0.00135} \) or 3
- **\( Z_\beta \)**: The number of standard deviations above zero on the standard normal distribution such that the area in the tail of the distribution is \( \beta \) (\( \beta \) is the type II error probability)
- **\( \sigma \)**: The standard deviation of the characteristic being charted
- **\( D \)**: The difference you are trying to detect

### \( Z_\alpha \) Values
- \( Z_{0.00135} = 3 \)
- \( Z_{0.01} = 2.33 \)
- \( Z_{0.025} = 1.96 \)
- \( Z_{0.05} = 1.64 \)
- \( Z_{0.10} = 1.28 \)
- \( Z_{0.20} = 0.84 \)

#### Example
Suppose a bottling plant is filling containers labeled as 12 ounces. The process standard deviation (\( \sigma \)) is estimated to be 0.12 ounces. What sample size is required to detect a shift (\( D \)) of 0.18 oz with 80% probability of success, or a 20% probability that the chart does not detect the shift (\( Z_\beta \))?

We have:
- \( Z_{\alpha/2} = Z_{0.00135} = 3 \)
- \( Z_\beta = Z_{0.20} = 0.84 \)
- \( \sigma = 0.12 \)
- \( D = 0.18 \) oz

\[
n = \frac{(3+0.84)^2 (0.12^2)}{0.18^2} = 6.55
\]

Thus, the required sample size (\( n \)) is rounded up to 7

### Steps for Constructing a Control Chart
The steps for constructing a control chart are as follows:
- Determine subgroup size or \( n \) (see 5.14.1.1)
- Collect 20 to 25 subgroups or Xs and Rs
- Calculate X (the average of all of the Xs)
- Calculate the R (the average of all of the Rs)
- Calculate the control limits using factor table
**Control Vs. Capability**

- **X Chart**
  - $UCL_X = \bar{X} + A_2 \bar{R}$
  - $LCL_X = \bar{X} - A_2 \bar{R}$

- **R Chart**
  - $UCL_R = D_4 \bar{R}$
  - $LCL_R = D_3 \bar{R}$

**Figure 5-14-1-2-1 Control Limit Factor Table**

**Figure 5-14-1-2-2** There is a direct relationship between the process distribution and the control limits.

**Figure 5-14-1-2-3** If the specification limits were superimposed, a capable process will show specification limits to be beyond the control limits.
Figure 5-14-1-2-4 If the specification limits are within the control limits, this is a sign of an incapable process, even if all points are within the control limits

Recognizing Out of Control Patterns

The typical out of control patterns of a control chart are (see Figure 5-14-1-4-1):

- One point outside of control limit. (minimum requirement)
- Five or more points trending up
- Five or more points trending down
- Five or more points on same side of the mean

Other Control Chart Patterns

The examples on the following pages will assist in recognizing typical control chart behavior and what may be behind it.
Trends
- machine wear
- tool wear
- raw material deterioration

Shifts in Process Level
- changes in proportions of materials coming from different sources
- shift changes or operator rotation
- changes in method or process
- changes in inspection or test devices
- over control or over adjustment

Recurring Cycles
- changes in environment (temperature, humidity, etc.)
- seasonality
- shift changes or operator rotation
Saw Tooth Pattern
- tool changes
- preventive maintenance
- chemical changes

Out of Control Point
- assignable cause such as:
  - misprocess
  - incorrect part used
  - incorrect raw material used
  - operator error
  - machine malfunction

Sudden Shift In Process
- process improvement
- change in raw materials
- machine malfunction
- tool failure or replacement
- inspection or test equipment replacement, calibration or malfunction
Reduction in Variability
- process improvement
- machine run-in or burn-in
  - once causes have been understood, control limits should be recalculated

Lack of Variability
- control limits calculated incorrectly
- control limits calculated a long time ago

When To Recalculate Control Limits
Control limits should be recalculated after a process change once the data clearly demonstrates a shift in process that is understood and can be explained.

*Note:* This can be confirmed via a t-Test or other statistical test.
5.3.5 Process Capability

A process capability study will determine the likelihood of a process to produce parts that are within specification (see Figure 5-14-2-1). This assumption is based on an understanding of the process spread as compared to the tolerance width.

Measures of Central Tendency

The measures of central tendency describe how the data are grouped together:

- The **mode** is the more frequently occurring number in a data set
- The **mean** (or average) is the total of all the data points divided by the number of data points

\[
\bar{X} = \frac{\sum X}{n}
\]

- The **median** is the middle number of the data points sorted by ascending order

Measures of Dispersion

The measures of dispersion describe the spread of the data:

- The range is the difference between the largest and smallest values in a set of data
- The standard deviation shows how much variation there is from the average (or mean)

\[
\sigma = \sqrt{\frac{\sum (X - \bar{X})^2}{n}}
\]
Histograms
A histogram stacks up numbers within certain ranges or “buckets”

Figure 5-14-2-3-1 Depiction of how to construct a Histogram

KEY POINT
A useful feature of the Standard Deviation is that almost all (i.e. 99.7%) of the data sits within +/- 3 Standard Deviation units from the mean

Figure 5-14-2-3-2 For this set of data we can say that there is a 99.7% probability that all of the data falls between 81 and 99
Capability Indices
There are several capability indices that can be calculated:

**Capability Ratio or \( C_R \)**

\[
C_R = \frac{6S}{\text{Tolerance Width}}
\]

**Capability Index or \( C_P \)**

\[
C_P = \frac{\text{Tolerance Width}}{6S}
\]

![Diagram of normal distribution]

\( C_P = \frac{10}{5} = 2.0 \) ✔

**Capability or \( C_{pk} \)**

\( C_{pk} \) is a capability index that does consider process centering. \( C_{pk} \) is the lesser of:

\[
C_{pk} = \frac{\bar{X} - LSL}{3S} \quad \text{or} \quad C_{pk} = \frac{USL - \bar{X}}{3S}
\]

- **USL** is the upper specification limit
- **LSL** is the lower specification limit
- **\( \bar{X} \)** is the process average
- **\( S \)** is the process standard deviation
5.4 Process Monitoring

5.4.1 Internal Process Audit Program
Suppliers should have an implemented and effective Internal Process Audit Program. The annual planning of the Internal Process Audit Program should encompass in scope the entire manufacturing process flow on all manufacturing shifts. Process auditing to process control plans is the known best-practice; evidence of this practice will reside in the program planning (as evident in the defined scopes of the planned process audits) and in the program execution (as evident in findings referencing specific process control plans and their content). Internal auditors should be formally trained. Audit findings should require formal corrective actions to achieve closure. The use of an 8D methodology, with strong emphasis on D4 and D7, is recommended as the best method to address audit findings. The health and effectiveness of the Internal Process Audit Program should be regularly assessed within the manufacturing organization’s management review process.

5.4.2 Maverick Lot Program (Outlier Identification and Management System)
Outliers should be identified for all CTQ (critical to quality) parameters in relation to the characterized parametric results of the process. In addition, yield results should be monitored to flag abnormally yielding product. For both parametric and yield limits, maverick or outlier status should result in required engineering investigation and disposition. Methods of defining maverick can be at 3sigma process deviation or practices such as Part Average Testing, SYL, SBL to screen out

![Figure 5-14-2-4-2 these figures show the relationship between Cpk values and process capability](image)
outliers within specification are recommended. Should outlier material be deemed suitable for shipment, the supplier must formally notify Skyworks. Reference to JESD-50 is also recommended.

5.4.3 Defect Monitoring and Reduction

Defined means for defect monitoring should be implemented, monitored and analyzed. Defect detection methods should be evident in both the process control plans and process FMEAs. The data from such tools should be monitored, and used to drive process improvement. Critical defects with low detectability must be reported to Skyworks. Suppliers to provide periodic defectivity report to demonstrate the continuous defectivity improvement activity. For suppliers with more than 1 manufacturing site for Skyworks, there should be cross sharing of defectivity improvement activities across all sites.

5.4.4 Yield Monitoring and Improvement

The organization should have a system and resources designated for the monitoring and analysis of process/product yield data. Yield analysis best practices include use of: Pareto analysis, stacked wafer analysis, radial zone analysis, and tool commonality correlation. The organization should be able to demonstrate regular review of statistical limits and the effective use of yield data to drive process improvement. End to end product yields <60% must be reported to Skyworks.

5.4.5 On-going & Outgoing Reliability Monitoring

Periodic monitoring of product reliability should be implemented for the production line. The on-going testing method, frequency and requirements should be defined. Failures should result in immediate corrective actions. Lastly, the test results should be regularly reviewed by management and available to customers upon request.

Outgoing reliability monitoring should be implemented on a per batch basis for critical products. Test Method, frequency & requirements can be discussed with relevant Skyworks Quality Engineers.

5.4.6 Measurement System Analysis
The objective of measurement system analysis or MSA is to understand, measure and minimize the amount of variation in the measurement systems used to determine product acceptability or gather SPC data (reference the AIAG MSA Manual). The organization’s MSA should include:

- Bias
- Stability
- Linearity
- Repeatability and Reproducibility

MSA should be performed on a regularly scheduled basis or after a measurement process change. Gage R&R studies should be performed using the ANOVA method based on the process variation width, not the tolerance width.

**Figure 5-10-1** Reproducibility and repeatability can be expressed as a percentage of the total specification width.

**Figure 5-10-2** or as a percentage of the total process variation (ANOVA). Using the specification width makes the Gage R&R values appear much lower however, may not provide an accurate assessment of the system’s ability to detect process shifts.

**KEY POINT**

Gage R&R measured as a percentage of total process variation is a better indicator of measurement system capability than measuring the percentage of tolerance width

### 5.4.7 Test Sample Size and Frequency

Test sample size and frequency should be carefully selected to ensure product quality. Process control plans should show correct sample size / AQL and frequency. Actual test and inspection practice should match AQL, sample size and AQL listed in control plan. Where sample inspection is used, the organization should be able to explain how sample size and
AQL were selected. Sampling plans should be based on sound statistical principles (OC curves) ANSI/ASQ Z1.4 or equivalent and should be zero acceptance (c=0) type plans. AQL sampling is only acceptable if there is an inspection point upstream that can detect any discrepant parts.

Figure 5-7-1 Zero Acceptance Sampling Plan. Using this chart, an AQL of .10 means that there is a 95% probability that no more than 0.10% of the parts in the lot are discrepant. That means that there is a 5% probability that more than 0.10% of the parts in the lot are discrepant.

5.4.8 Fault Detection Control

Skyworks encourages suppliers to implement fault detection control capability for real time monitoring of the process parameters. Reaction plans for the critical parameters should be formally implemented to support timely intervention for reduction of products at risk.

5.5 Problem Solving Methodology

5.5.1 Methodology Requirements

The organization should use a comprehensive, proven and defined problem-solving methodology such as five-phase, 8D (see Figure 5-5-1), 3 x five-why, drill deep and wide, cause & effect, fishbone (see Figure 5-5-2), DMAIC, DISC, etc. There should be evidence of how problem solving techniques were used while developing the production process.

The problem solving methodology should include:

- problem definition
- containment
- how these techniques identified all root causes (i.e. symptoms, contributing and systemic causes)
• demonstrate all actions were actually deployed and that show actions were realistic and sustainable
• verify actions were successful in preventing the problem from reoccurring

For suppliers with more than 1 manufacturing site for Skyworks, there should be risk assessment and cross sharing of lesson learned across all the sites and this information to be provided to Skyworks upon request.

5.5.2 Root Cause Analysis Tools

Failure Analysis
Failure analysis techniques appropriate to the suppliers manufacturing technology should be identified. Plans for potential utilization of such resources and techniques should exist. If FA resources exist at the supplier, the FA lab should fall within the formal QMS certification scope of the supplier.

3 x Five-Why Analysis
Five-why analysis is a question based method used to determine the cause and effect relationships related to a particular problem. Five-why analysis is used to determine the root cause of a problem or defect. It is based on the premise that asking “why” five times will get to the root cause of the problem. Best practices include use of a “3 x 5-Why” approach where three 5-Why analyses are conducted. The three dimensions of this analysis are generally called: Process, Detec-
tion and System. The "Process 5-Why" addresses the root cause of the failure. The "Detection 5-Why" addresses the cause of the failure to detect and contain the problem once it had occurred. The "System 5-Why" addresses the failure of the system to stop the failure from happening.

**KEY POINT**

The last answer in a five-why analysis will typically point to a process problem.

**Fishbone Diagram**

The fishbone diagram (or Ishikawa diagram) allows a team to explore and graphically display all of the causes and contributing causes related to a problem. The team members brainstorm the major causes and place them in the appropriate category. Then they repeatedly ask "why" for each cause until the team runs out of causes. This results in a nested list of causes, contributing causes and root causes.

![Fishbone Diagram](image)

Figure 5-5-3 Fishbone Diagram or Ishikawa Diagram

**5.6 Robust Quality Management Systems**

**5.6.1 Error / Mistake Proofing**

Error or mistake proofing places an emphasis on the use of controls that make it physically impossible to make a mistake. Error proofing methodologies should be captured in the control plan. The organization should be able to show examples of error proofing and mistake proofing approaches used to improve the production process. Mistake proofing alerts the operator that an error has been made. Error proofing physically prevents the operator from making a mistake. Targets for error proofing should be identified based on manual processes, scrap cost Pareto analysis (i.e. allocates error proofing resources to highest offenders resulting on the best return on investment) and FMEA risk assessments.

Error / Mistake Proof through the use of eSystems such as MES (manufacturing execution systems), RMS (recipe management systems), eSPC (electronic statistical process control software) are strongly encouraged. These systems can be purchased from 3rd party or develop by supplier own IT. Example of functions of a close loop Poka Yoke systems includes...
MES auto lot hold when non confirming lots is detected by SPC, use of barcodes for recipe selection, expiry / shelf life of consumables being track by MES systems. Measurement machine sends the data to SPC system directly.

5.6.2 Traceability and Exposure

During production, raw materials details, process details should be recorded for root cause analysis & commonality study as needed. Such information must be stored for easy records retrieval in the MES or other systems for quick data retrieval instead of paper / hardcopy. Backward traceability from information provided by Skyworks must be completed within 24 hours. A good traceability system must be designed to factor in lot size & material merging when shipping material to Skyworks to limit exposure of bad material contamination to large amount of good material.

5.7 Preventive Maintenance

By proactively maintaining manufacturing equipment, performance will be predictable and equipment availability will be maximized. The organization should perform preventive maintenance on key process equipment and there should be a plan in place that defines the activities and frequency. Best practices include the use of data to determine predictive maintenance plans, the use of failure mode effects analysis (FMEA) to gauge and reduce equipment risks, and electronic-PM system to manage PM activities and prevent machine usage of overdue equipment.

5.8 Incoming Material Certification

Material used in the factory should always conform to specifications and be consistent, predictable and stable. Sample size and criteria should be defined and based on sound statistical methods. There should be evidence that material is being inspected as stated on the control plan. Control charts should be used to monitor consistency of incoming material (see Figure 5-6-1).

**KEY POINT**

The output of any process (no matter how good the controls are) depends largely on the quality of the input materials.
Figure 5-6-1 The use of SPC to monitor the stability of incoming raw materials is an effective means of minimizing variation on the manufacturing floor

5.9 Five-S

The Five-S philosophy ensures the organization has a clean workplace that is free from clutter, where things are easy to find, easy to use and easy to put back in place. Five-S is based on the following five principles:

- Sort - eliminate unnecessary tools, parts, equipment: only keep essential items
- Straighten - a place for everything and everything in its place
- Shine - clean the area in a manner consistent with the needs
- Standardize - work practices should be documented for the first 3 S's
- Sustain - continuously maintain and review work practices

A review of the work area should show that:

- unneeded items have been removed
- required items (e.g. tools, materials, work instructions) are within the immediate vicinity
- the area is free from clutter
- items are easy to locate and easy to put back in place
- the 5S standardized checklist is being used on a regular basis
Figure 5-16-1 Area is well organized, items are labeled

Figure 5-16-2 Before and After Five S

Figure 5-16-3 Before and After Five S
5.10 Process Floor Layout

The process floor layout helps optimize material travel, handling, value added use of floor space and facilitates synchronous material flow (i.e. the right amount of material in the right sequence and position). The organization should have a floor layout that represents the entire manufacturing process from receiving through shipping. The floor layout should be updated as new equipment is introduced or as equipment is retired. Having floor layouts by area is acceptable. Spaghetti Diagram approach is preferred. The floor layout and actual factory layout should match.

Figure 5-2-1 This example depicts the process flow of a school kitchen before process and floor layout analysis and optimization. The lines represent the employee and food travel. The boxed numbers represent the process steps.
5.11 Pre-HVM Review procedure & Clean Launch Program

A supplier must have a robust pre-HVM launch to monitor the newly qualified processes & products for a specific period of time. Practices such as APQP, PRP are recommended. Systematic review of the data collected can help to define plans for continuous improvement. Skyworks uses a Clean Launch program to monitor the first 30 lots for production. Clean Launch Programs may include additional sampling plans or additional tightened controls compared to standard production. Clean launch may be focused on specific new technologies or critical parts.

5.12 Sub Supplier Enhanced Management Plan

For critical sub suppliers, the contents of this spec may be applied & a PCO may be conducted.